











SFMC SERIES

BLE PIN COUNT TIGER EYE" SOCKET

SPECIFICATIONS

(1.27 mm) .050"

For complete specifications and recommended PCB layouts see www.samtec.com?SFMC

Insulator Material:

Black Liquid Crystal Polymer Contact Material: Tiger Eye™ = BeCu Tiger Eye™ LITE= Phosphor Bronze

Phosphor Diolize
Plating:
Au or Sn over
50 μ" (1.27 μm) Ni
Operating Temp Range:
-55 °C to +125 °C
Contact Resistance:
15 mΩ

15 m Ω

Insertion Depth: (3.05 mm) .120" to (4.06 mm) .160"

Normal Force:

Standard= 132 g (1.29 LIF= 90 g (0.88 N) avg. (1.29 N) avg.

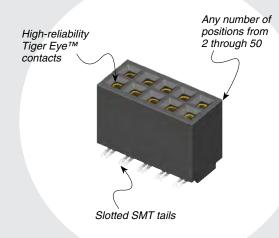
Max Cycles: 10,000 with 30 μ" (0.76 μm) Au **RoHS Compliant:**

Board Mates:

Cable Mates:

FMTP, FFMD





Available with optional pick & place pads

OPTION

PROCESSING

Lead-Free Solderable:

SMT Lead Coplanarity: (0.10 mm) .004" max (02-26) (0.15 mm) .006" max (27-50)

RECOGNITIONS

For complete scope of recognitions see www.samtec.com/quality





ALSO AVAILABLE (MOQ Required)

· Other platings Contact Samtec.

*Note: Standard FFMD callout will not mate with FLE, SFMC. Must use gold plated callouts. (See drawing on web.)

Note: Some sizes, styles and options are non-standard. non-returnable.



LEAD

STYLE

01, -L1, -T1

-03, -L3

(0.51)

.020

02 thru 50

В

(0.51) .020

(0.41) .016

(3.05)

(1.91)

LEAD STYLE

-01, -03 = Through-hole

−L1, −L3 Low Insertion Force Through-hole

-02= Surface Mount

-L2 = Low Insertion Force **Surface Mount**

= Through-hole Tiger Eye™ LITE

-T2 = Surface Mount Tiger Eye™ LITE = 10 µ" (0.25 µm) Gold on contact,

(10.00)

- x (5.72)

(1.27).050

PLATING

OPTION

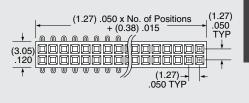
= (4.00 mm) .157 DIA Polyimide film Pick & Matte Tin on tail Place Pad (4 positions

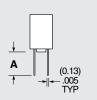
D

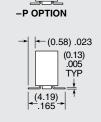
-P = Plastic Pick & Place Pad (5 positions minimum)

minimum)

–TR = Tape & Reel







B → | |-

(4.57) .180